

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Stephen P. Zadesky	10/14/2011
Fletcher R. Rothkopf	10/14/2011
Anna-Katrina Shedletsky	10/14/2011
RECEIVING PARTY DATA	
Name:	APPLE INC.
Street Address:	1 Infinite Loop
City:	Cupertino
State/Country:	CALIFORNIA
Postal Code:	95014
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13298842
CORRESPONDENCE DATA	
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Correspondent Name:	A. Richard Park
Address Line 1:	Park, Vaughan, Fleming & Dowler LLP
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ATTORNEY DOCKET NUMBER:	APL-P11325US1
NAME OF SUBMITTER:	A. Richard Park, Reg. No. 41,241
Total Attachments: 1 source=APL-P11325US1_Assignment#page1.tif	

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned do hereby sell, assign and transfer to: APPLE INC., a corporation of California, having a principal place of business at 1 Infinite Loop, Cupertino, California 95014 ("Assignee"), its successors, assigns, and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any improvements which are disclosed in the application for the United States Letters Patent,

[] which has been executed by the undersigned concurrently herewith,

[X] which was filed on 17 November 2011 and assigned U.S. Serial No: 13/298,842 and is entitled:

AMORPHOUS DIAMOND-LIKE CARBON COATINGS FOR INCREASING THE THERMAL CONDUCTIVITY OF STRUCTURAL FRAMES IN PORTABLE ELECTRONIC DEVICES

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application; and

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns and legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 10/14/11 Name: Stephen P. Zadesky

Signature: [Signature]

Date: 10/14/11 Name: Fletcher R. Rothkopf

Signature: [Signature]

Date: 10/14/11 Name: Anna-Katrina Shedletsky

Signature: [Signature]

Date: _____ Name: _____

Signature: _____

Date: _____ Name: _____

Signature: _____